

Title (en)

Method for sealing a device such as an induction coil

Title (de)

Verfahren zum Abdichten einer Vorrichtung wie einer Induktionspule

Title (fr)

Procédé d'étanchéification d'une pièce telle qu'une bobine d'induction

Publication

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Application

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Priority

FR 9105120 A 19910425

Abstract (en)

[origin: EP0511062A1] Method for sealing a device such as an induction coil and mould for carrying out the method. The subject of the invention is a method for sealing a device such as an induction coil. For this purpose, the device is shrouded in a heat-settable vinyl resin (3). <IMAGE>

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H01F 41/12; B05D 1/00

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H01F 41/127 (2013.01)

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- DERW/WPI,Jap.Abs.80-24601C,8014
- DERW/WPI,Jap.Abs.78-59808A,7833
- DERW/WPI,Jap.Abs.90-182614,9024
- DERW/WPI,Jap.Abs.82-04654E,8203
- Pat.Abs.Jap.13,no.42.,30/01/89

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